



PATENT

Attorney Docket No.: SAM-0313CIP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kyoung-woo Lee, *et al.*

Examiner: Nguyen, Ha T.

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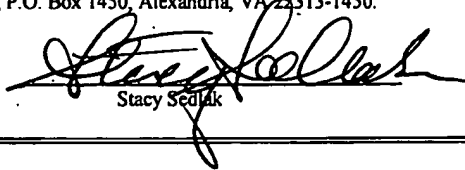
Title: METHOD OF FABRICATING DUAL DAMASCENE INTERCONNECTIONS  
OF MICROELECTRONIC DEVICE USING HYBRID LOW K-DIELECTRIC  
AND CARBON-FREE INORGANIC FILLER

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P.O. Box 1450

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AMENDMENT AFTER FINAL REJECTION

Sir:

This is in response to the final Office Action mailed on November 15, 2005 and is filed within the shortened statutory period of three months. It is requested that the following amendments be entered and that the following remarks be considered.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 10 of this paper.